



Connectors > Socket Connectors > Memory Sockets > SO DIMM Sockets > DDR3 SO DIMM Sockets



DRAM Type: Double Data Rate (DDR) 2

Stack Height: 5.2 mm [.205 in]

Module Orientation: Right Angle

Number of Positions: 144

Centerline (Pitch): .8 mm [.031 in]

[All DDR3 SO DIMM Sockets \(12\)](#)

Features

Product Type Features

Connector System	Cable-to-Board
Connector & Contact Terminates To	Printed Circuit Board
DRAM Type	Double Data Rate (DDR) 2

Configuration Features

Number of Bays	2
Number of Keys	1
Number of Rows	2
Module Orientation	Right Angle
Number of Positions	144

Electrical Characteristics

DRAM Voltage	1.8 V
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Signal Characteristics

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SGRAM Voltage	1.8 V
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Body Features

Ejector Location	Both Ends
Latch Material	Stainless Steel
Latch Plating Material	Tin
Module Key Type	SGRAM
Ejector Type	Locking
Connector Profile	Standard

Contact Features

Memory Socket Type	Memory Card
PCB Contact Termination Area Plating Material	Gold
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.25 µm[9.84 µin]

Termination Features

Insertion Style	Cam-In
Termination Method to Printed Circuit Board	Surface Mount

Mechanical Attachment

Mating Alignment Type	Standard Keying
PCB Mount Retention	With
PCB Mount Retention Type	Hold-Down Post
Connector Mounting Type	Board Mount

Housing Features

Housing Material	High Temperature Thermoplastic
Housing Color	Black
Centerline (Pitch)	.8 mm[.031 in]

Dimensions

Stack Height	5.2 mm[.205 in]
Row-to-Row Spacing	6.2 mm[.244 in]

Usage Conditions

Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
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Operation/Application



Circuit Application	Signal
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Industry Standards

UL Flammability Rating	UL 94V-0
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Packaging Features

Packaging Quantity	200
Packaging Method	Tape & Reel

Product Compliance

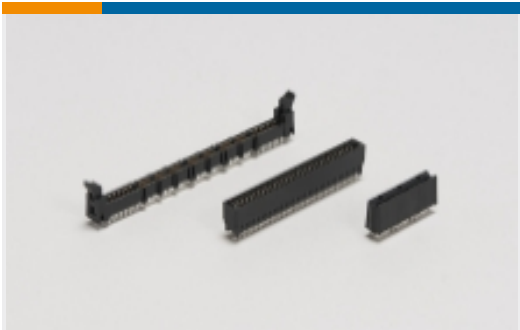
For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

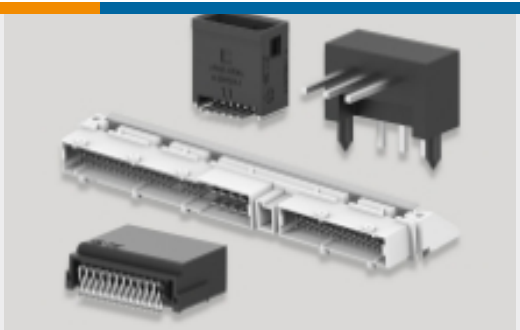
Also in the Series | AMP-METRIMATE



Card Edge Power Connectors(1)



Connector Hardware(1)



PCB Headers & Receptacles(3)



Rack & Panel Connectors(1)



Rectangular Power Connectors(9)



RJ45 Connectors(45)



SO DIMM Sockets(12)

Also in the Series

DDR2 SO DIMM



SO DIMM Sockets(24)

Customers Also Bought



TE Part #5747843-4
37 MSFL PLUG RA 318 (IN,FM,BL)



TE Part #2-1761605-3
IDC LOW PRO HDR 10P RA BLUE



TE Part #643426-3
09P UMNL SOK HDR ASSY POL LF



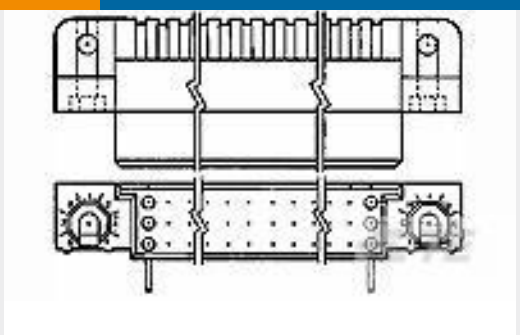
TE Part #643414-3
03P UMNL HDR ASSY POL 94VO LF



TE Part #1-770859-1
15P MINI UMNL HDR ASSY AU LF



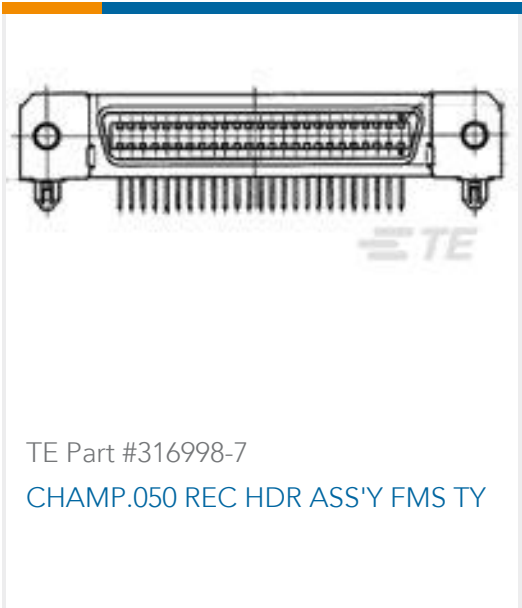
TE Part #1857995-1
Z-PACK/B F-HDR.125P, EON



TE Part #1-532431-1
HDI RECP ASSY 3 ROW 210 POS



TE Part #2101423-1
A600R,Sz3,Q11/Q11/blk/Q11/Q11/85



Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-1735251-2_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-1735251-2_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-1735251-2_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Product Specifications

Product Specification

English

Socket, 144 Position Surface Mount 8 Byte SO DIMM

English